

## Features

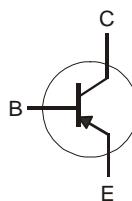
- Epitaxial Planar Die Construction
- Ideal for Low Power Amplification and Switching
- Ultra Small Surface Mount Package
- "Lead Free", RoHS Compliant (Note 1)**
- Halogen and Antimony Free, "Green Device" (Note 2)**
- ESD rating: 400V-MM, 8KV-HBM**

## Mechanical Data

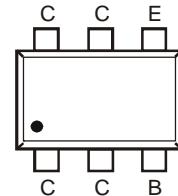
- Case: SOT-363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin annealed over Copper Plated Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.006 grams (approximate)



Top View



Device Symbol



Top View  
Pin Out Configuration

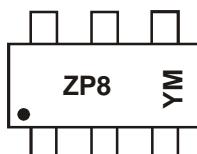
## Ordering Information (Note 3)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DSS5240Y-7	ZP8	7	8mm	3,000

Notes:

1. No purposefully added lead.
2. Diodes Inc's "Green" Policy can be found on our website at <http://www.diodes.com>
3. For packaging details, go to our website at <http://www.diodes.com>

## Marking Information



ZP8 = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year (ex: W = 2009)  
 M = Month (ex: 9 = September)

### Date Code Key

Year	2009	2010	2011	2012	2013	2014	2015	2016				
Code	W	X	Y	Z	A	B	C	D				
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Maximum Ratings** @  $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	-40	V
Collector-Emitter Voltage	$V_{CEO}$	-40	V
Emitter-Base Voltage	$V_{EBO}$	-5	V
Collector Current - Continuous	$I_C$	-2	A
Peak Pulse Collector Current	$I_{CM}$	-3	A
Base Current (DC)	$I_B$	-300	mA
Peak Base Current	$I_{BM}$	-1	A

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4) @ $T_A = 25^\circ\text{C}$	$P_D$	625	mW
Thermal Resistance, Junction to Ambient (Note 4) @ $T_A = 25^\circ\text{C}$	$R_{\theta JA}$	200	°C/W
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	°C

Notes: 4. Device mounted on FR-4 PCB, with minimum recommended pad layout.

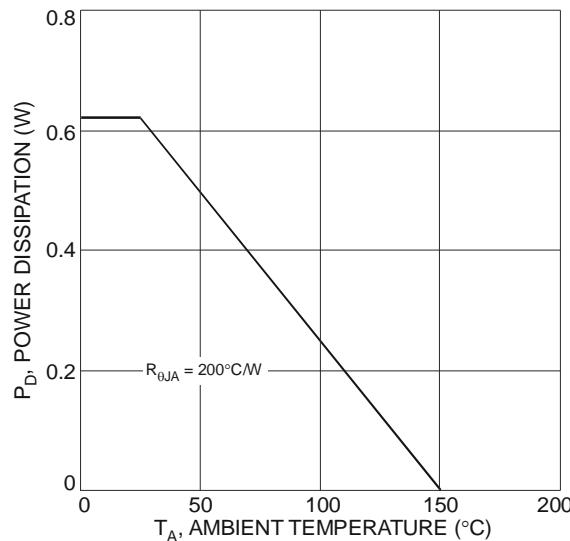


Fig. 1 Power Dissipation vs. Ambient Temperature (Note 4)

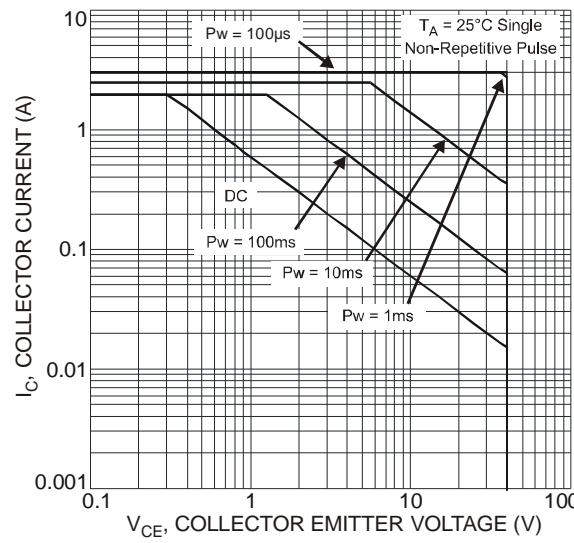


Fig. 2 Safe Operating Area

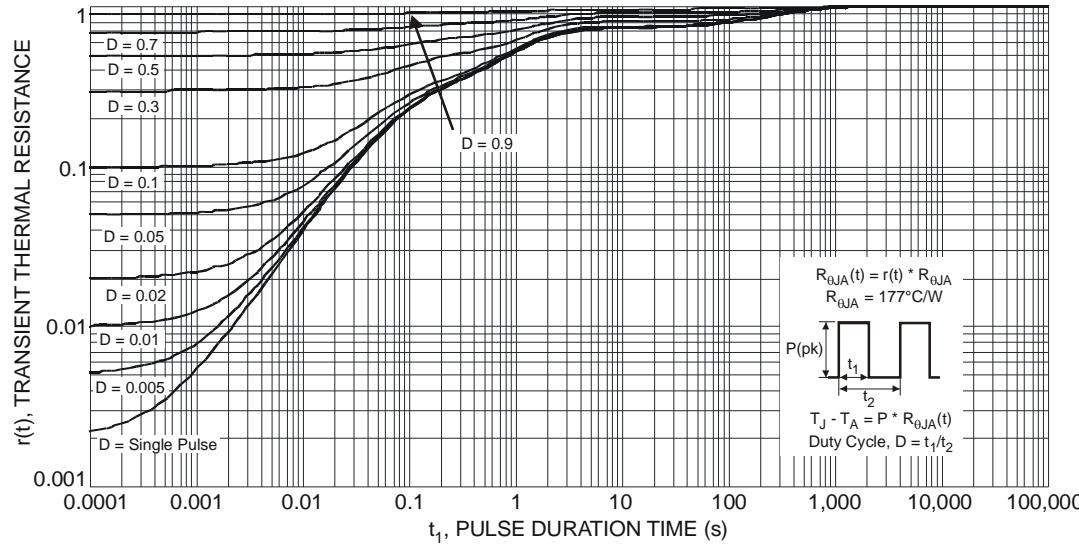
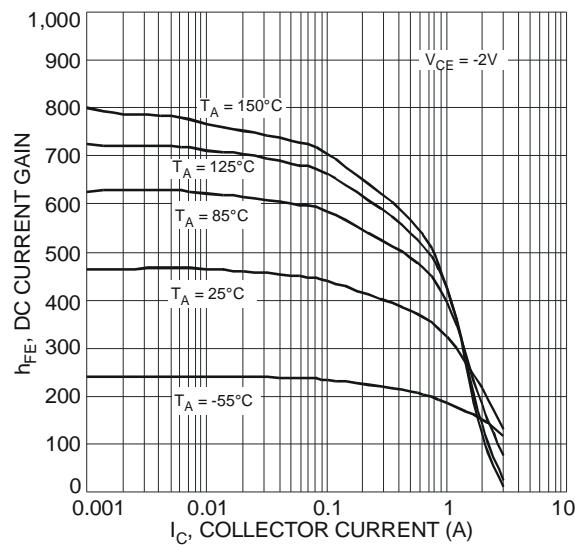
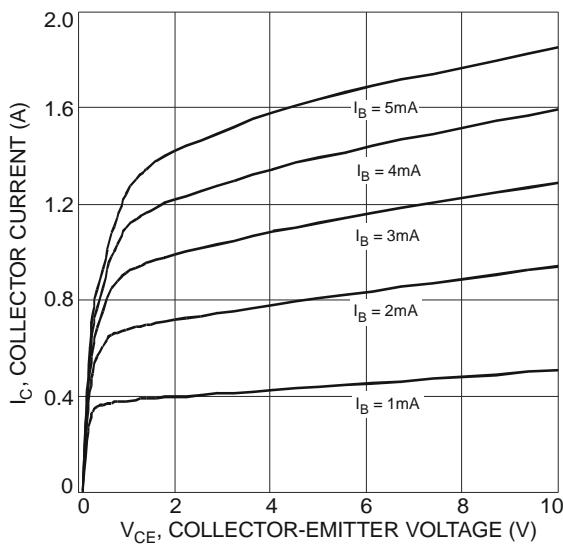


Fig. 3 Transient Thermal Response

**Electrical Characteristics** @  $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	$\text{BV}_{\text{CBO}}$	-40	—	—	V	$I_C = -100\mu\text{A}, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 5)	$\text{BV}_{\text{CEO}}$	-40	—	—	V	$I_C = -10\text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	$\text{BV}_{\text{EBO}}$	-5	—	—	V	$I_E = -100\mu\text{A}, I_C = 0$
Collector Cutoff Current	$I_{\text{CBO}}$	—	—	-100 -50	nA $\mu\text{A}$	$V_{\text{CB}} = -30\text{V}, I_E = 0$ $V_{\text{CB}} = -30\text{V}, I_E = 0, T_A = 150^\circ\text{C}$
Emitter Cutoff Current	$I_{\text{EBO}}$	—	—	-100	nA	$V_{\text{EB}} = -4\text{V}, I_C = 0$
DC Current Gain (Note 5)	$h_{\text{FE}}$	300 260 210 100	450 380 325 210	—	—	$V_{\text{CE}} = -2\text{V}, I_C = -100\text{mA}$ $V_{\text{CE}} = -2\text{V}, I_C = -500\text{mA}$ $V_{\text{CE}} = -2\text{V}, I_C = -1\text{A}$ $V_{\text{CE}} = -2\text{V}, I_C = -2\text{A}$
Collector-Emitter Saturation Voltage (Note 5)	$V_{\text{CE}(\text{sat})}$	— — — — —	— — — — —	-100 -110 -225 -225 -350	mV	$I_C = -100\text{mA}, I_B = -1\text{mA}$ $I_C = -500\text{mA}, I_B = -50\text{mA}$ $I_C = -750\text{mA}, I_B = -15\text{mA}$ $I_C = -1\text{A}, I_B = -50\text{mA}$ $I_C = -2\text{A}, I_B = -200\text{mA}$
Collector-Emitter Saturation Resistance	$R_{\text{CE}(\text{sat})}$	—	—	-220	$\text{m}\Omega$	$I_C = -500\text{mA}, I_B = -50\text{mA}$
Base-Emitter Saturation Voltage (Note 5)	$V_{\text{BE}(\text{sat})}$	—	-1.0	-1.1	V	$I_C = -2\text{A}, I_B = -200\text{mA}$
Base-Emitter Turn On Voltage (Note 5)	$V_{\text{BE}(\text{on})}$	—	-0.67	-0.75	V	$V_{\text{CE}} = -2\text{V}, I_C = -100\text{mA}$
Output Capacitance	$C_{\text{obo}}$	—	25	40	pF	$V_{\text{CB}} = -10\text{V}, f = 1.0\text{MHz}$
Current Gain-Bandwidth Product	$f_T$	100	220	—	MHz	$V_{\text{CE}} = -10\text{V}, I_C = -50\text{mA}, f = 100\text{MHz}$
Turn-On Time	$t_{\text{on}}$	—	73	—	ns	$V_{\text{CC}} = -10\text{V}$ $I_C = -1\text{A}, I_{\text{B}1} = I_{\text{B}2} = -50\text{mA}$
Delay Time	$t_d$	—	27	—	ns	
Rise Time	$t_r$	—	46	—	ns	
Turn-Off Time	$t_{\text{off}}$	—	237	—	ns	
Storage Time	$t_s$	—	195	—	ns	
Fall Time	$t_f$	—	42	—	ns	

Notes: 5. Measured under pulsed conditions. Pulse width = 300 $\mu\text{s}$ . Duty cycle  $\leq 2\%$ .



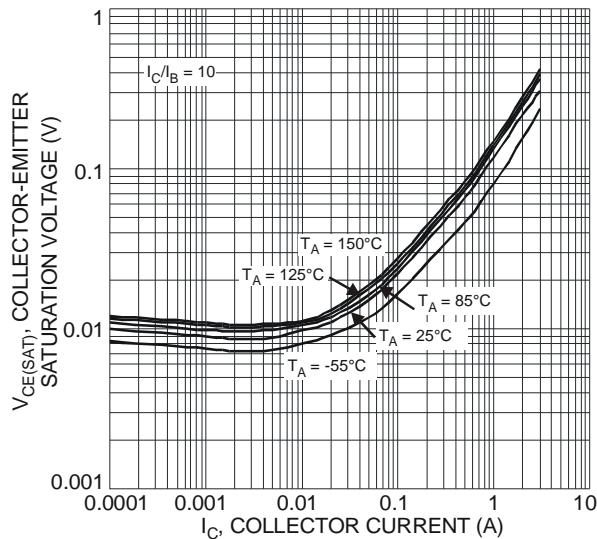


Fig. 6 Typical Collector-Emitter Saturation Voltage vs. Collector Current

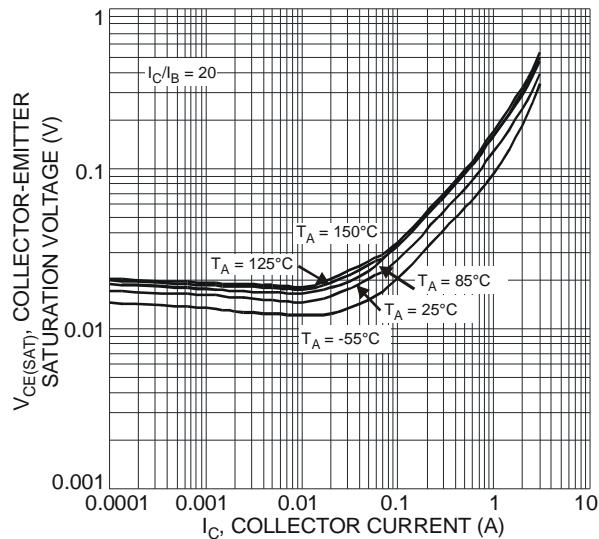


Fig. 7 Typical Collector-Emitter Saturation Voltage vs. Collector Current

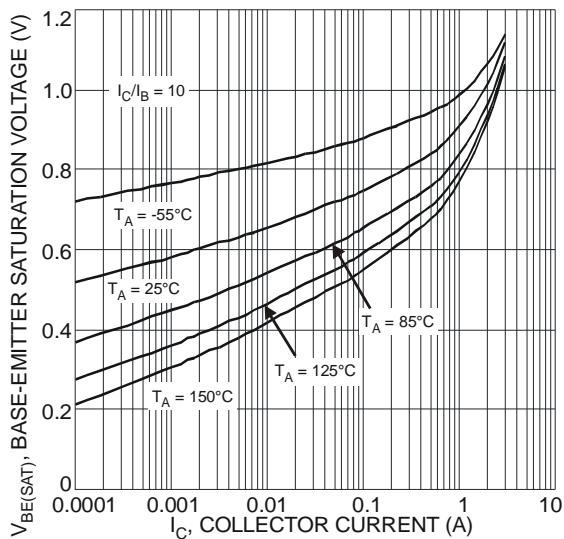


Fig. 8 Typical Base-Emitter Saturation Voltage vs. Collector Current

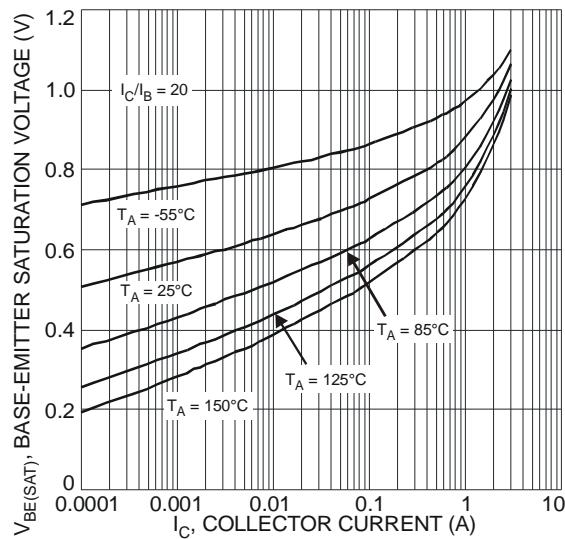


Fig. 9 Typical Base-Emitter Saturation Voltage vs. Collector Current

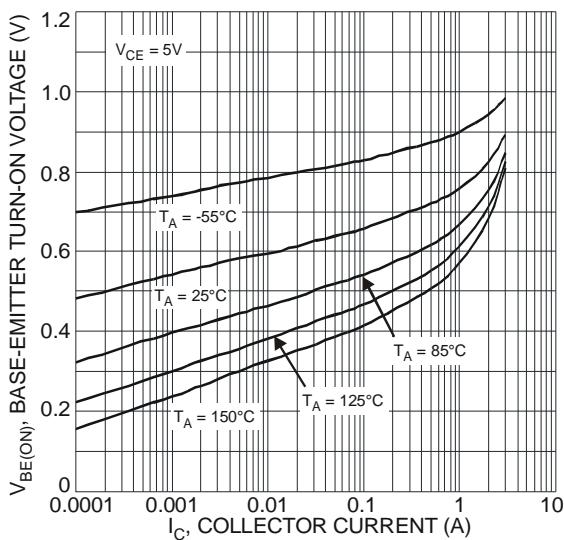
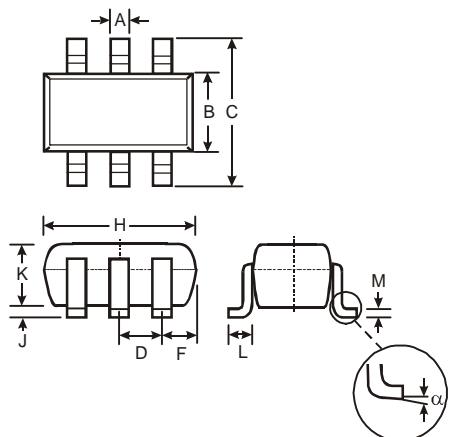


Fig. 10 Typical Base-Emitter Turn-On Voltage vs. Collector Current

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## Package Outline Dimensions

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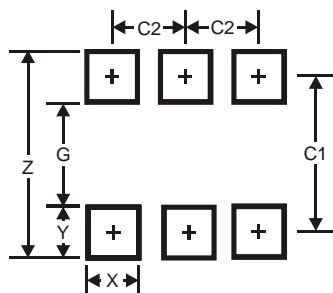
SOT-363		
Dim	Min	Max
A	0.10	0.30
B	1.15	1.35
C	2.00	2.20
D	0.65 Typ	
F	0.40	0.45
H	1.80	2.20
J	0	0.10
K	0.90	1.00
L	0.25	0.40
M	0.10	0.22
$\alpha$	0°	8°

All Dimensions in mm

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## Suggested Pad Layout

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Dimensions	Value (in mm)
Z	2.5
G	1.3
X	0.42
Y	0.6
C1	1.9
C2	0.65

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